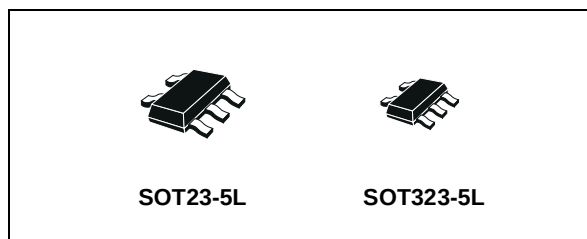


SINGLE BUS BUFFER (3-STATE)

- 5V TOLERANT INPUTS
- HIGH SPEED: $t_{PD} = 4.5\text{ns}$ (MAX.) at $V_{CC} = 3\text{V}$
- LOW POWER DISSIPATION:
 $I_{CC} = 1\mu\text{A}$ (MAX.) at $T_A = 25^\circ\text{C}$
- POWER DOWN PROTECTION ON INPUTS AND OUTPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:
 $|I_{OH}| = I_{OL} = 24\text{mA}$ (MIN) at $V_{CC} = 3\text{V}$
- BALANCED PROPAGATION DELAYS:
 $t_{PLH} \cong t_{PHL}$
- OPERATING VOLTAGE RANGE:
 $V_{CC}(\text{OPR}) = 1.65\text{V}$ to 5.5V
(1.2V Data Retention)
- IMPROVED LATCH-UP IMMUNITY



ORDER CODES

PACKAGE	T & R
SOT23-5L	74LX1G126STR
SOT323-5L	74LX1G126CTR

DESCRIPTION

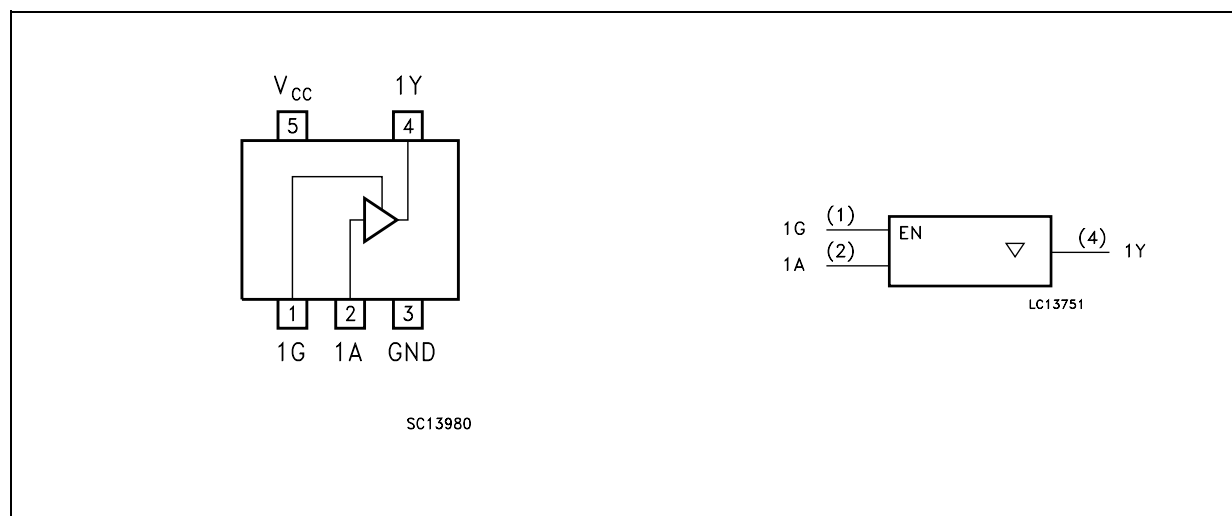
The 74LX1G126 is a low voltage CMOS SINGLE BUS BUFFER fabricated with sub-micron silicon gate and double-layer metal wiring C²MOS technology.

3-STATE control input G has to be set LOW to place the output into the high impedance state.

Power down protection is provided on all inputs and 0 to 7V can be accepted on inputs with no regard to the supply voltage. This device can be used to interface 5V to 3V.

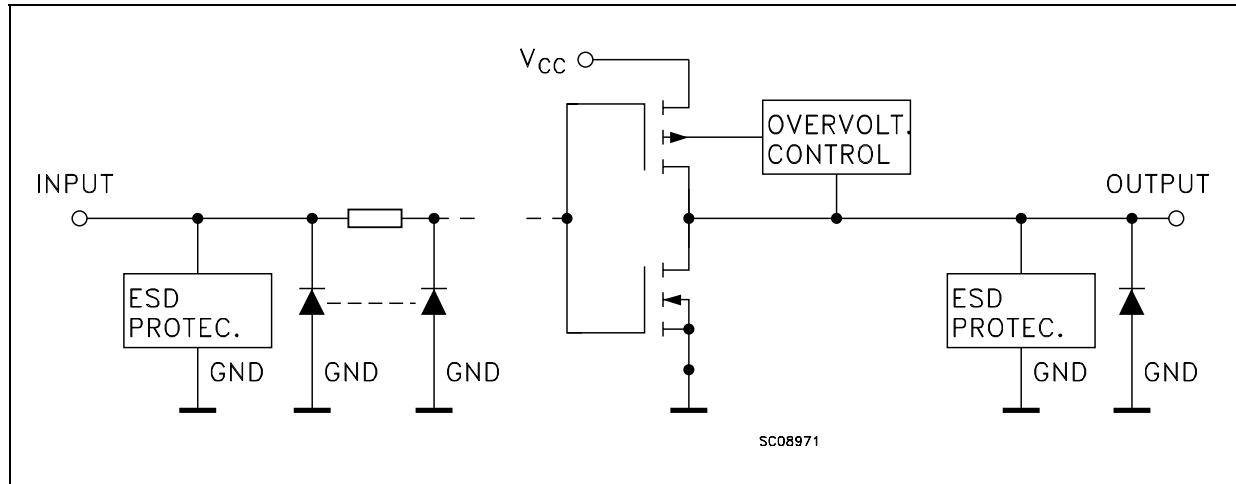
All inputs and outputs are equipped with protection circuits against static discharge.

PIN CONNECTION AND IEC LOGIC SYMBOLS



74LX1G126

INPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
1	1G	Output Enable Input
2	1A	Data Input
4	1Y	Data Output
3	GND	Ground (0V)
5	V _{CC}	Positive Supply Voltage

TRUTH TABLE

A	G	Y
X	L	Z
L	H	L
H	H	H

X : Don't Care

Z : High Impedance

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	-0.5 to +7.0	V
V _I	DC Input Voltage	-0.5 to +7.0	V
V _O	DC Output Voltage (V _{CC} = 0V)	-0.5 to +7.0	V
V _O	DC Output Voltage (High or Low State) (note 1)	-0.5 to V _{CC} + 0.5	V
I _{IK}	DC Input Diode Current	- 50	mA
I _{OK}	DC Output Diode Current (note 2)	- 50	mA
I _O	DC Output Current	± 50	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current per Supply Pin	± 50	mA
T _{stg}	Storage Temperature	-65 to +150	°C
T _L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

1) I_O absolute maximum rating must be observed

2) V_O < GND, V_O > V_{CC}

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage (note 1)	1.65 to 5.5	V
V_I	Input Voltage	0 to 5.5	V
V_O	Output Voltage ($V_{CC} = 0V$)	0 to 5.5	V
V_O	Output Voltage (High or Low State)	0 to V_{CC}	V
I_{OH}, I_{OL}	High or Low Level Output Current ($V_{CC} = 4.5$ to $5.5V$)	± 32	mA
I_{OH}, I_{OL}	High or Low Level Output Current ($V_{CC} = 3.0$ to $3.6V$)	± 24	mA
I_{OH}, I_{OL}	High or Low Level Output Current ($V_{CC} = 2.7$ to $3.0V$)	± 12	mA
I_{OH}, I_{OL}	High or Low Level Output Current ($V_{CC} = 2.3$ to $2.7V$)	± 8	mA
I_{OH}, I_{OL}	High or Low Level Output Current ($V_{CC} = 1.65$ to $2.3V$)	± 4	mA
T_{op}	Operating Temperature	-55 to 125	°C
dt/dv	Input Rise and Fall Time (note 2)	0 to 10	ns/V

1) Truth Table guaranteed: 1.2V to 3.6V

2) V_{IN} from 0.8V to 2V at $V_{CC} = 3.0V$

DC SPECIFICATIONS

Symbol	Parameter	Test Condition		Value				Unit
		V _{CC} (V)		-40 to 85 °C		-55 to 125 °C		
				Min.	Max.	Min.	Max.	
V _{IH}	High Level Input Voltage	1.65 to 1.95		0.75V _{CC}		0.75V _{CC}		V
		2.3 to 2.7		0.7V _{CC}		0.7V _{CC}		
		3.0 to 5.5		0.7V _{CC}		0.7V _{CC}		
V _{IL}	Low Level Input Voltage	1.65 to 1.95			0.25V _{CC}		0.25V _{CC}	V
		2.3 to 2.7			0.3V _{CC}		0.3V _{CC}	
		3.0 to 5.5			0.3V _{CC}		0.3V _{CC}	
V _{OH}	High Level Output Voltage	1.65 to 4.5	I _O =-100 μA	V _{CC} -0.1		V _{CC} -0.1		V
		1.65	I _O =-4 mA	1.2		1.2		
		2.3	I _O =-8 mA	1.9		1.9		
		3.0	I _O =-16 mA	2.4		2.4		
			I _O =-24 mA	2.2		2.2		
		4.5	I _O =-32 mA	3.8		3.8		
V _{OL}	Low Level Output Voltage	1.65 to 4.5	I _O =100 μA		0.1		0.1	V
		1.65	I _O =4 mA		0.45		0.45	
		2.3	I _O =8 mA		0.3		0.3	
		3.0	I _O =16 mA		0.4		0.4	
			I _O =24 mA		0.55		0.55	
		4.5	I _O =32 mA		0.55		0.55	
I _{OZ}	High Impedance Output Leakage Current	3.6	V _I = 0 to 5.5V		± 10		± 10	μA
I _I	Input Leakage Current	1.65 to 5.5	V _I = 0 to 5.5V		± 10		± 10	μA
I _{off}	Power Off Leakage Current	0	V _I or V _O = 5.5V		10		10	μA
I _{CC}	Quiescent Supply Current	1.65 to 5.5	V _I = V _{CC} or GND		10		10	μA
		3.6	V _I or V _O = 3.6 to 5.5V		± 10		± 10	

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3\text{ns}$)

Symbol	Parameter	Test Condition				Value				Unit
		V _{CC} (V)	C _L (pF)	R _L (Ω)	t _s = t _r (ns)	-40 to 85 °C		-55 to 125 °C		
						Min.	Max.	Min.	Max.	
t _{PLH} t _{PHL}	Propagation Delay Time	1.65 to 1.95	15	1MΩ	3.0	2	12.0	2	12.0	ns
		2.3 to 2.7				2	7.0	2	7.0	
		3.0 to 3.6				1	4.7	1	4.7	
		4.5 to 5.5				1	4.1	1	4.1	
		1.65 to 1.95	30	1000	2.0	2	8.0	2	8.0	
		2.3 to 2.7	30	500	2.0	2	5.5	2	5.5	
		2.7	50	500	2.5	1	5.2	1	5.2	
		3.0 to 3.6	50	500	2.5	1	4.5	1	4.5	
4.5 to 5.5	50	500	2.5	1	4.0	1	4.0			
t _{PLZ} t _{PHZ}	Output Disable Time	1.65 to 1.95	15	1MΩ	3.0	2	12.0	2	12.0	ns
		2.3 to 2.7				2	7.0	2	7.0	
		3.0 to 3.6				1	5.5	1	5.5	
		4.5 to 5.5				1	5.0	1	5.0	
		1.65 to 1.95	30	1000	2.0	2	9.8	2	9.8	
		2.3 to 2.7	30	500	2.0	2	6.0	2	6.0	
		2.7	50	500	2.5	1	5.7	1	5.7	
		3.0 to 3.6	50	500	2.5	1	5.5	1	5.5	
4.5 to 5.5	50	500	2.5	1	4.2	1	4.2			
t _{PZL} t _{PZH}	Output Enable Time	1.65 to 1.95	15	1MΩ	3.0	2	12.0	2	12.0	ns
		2.3 to 2.7				2	7.0	2	7.0	
		3.0 to 3.6				1	6.0	1	6.0	
		4.5 to 5.5				1	5.5	1	5.5	
		1.65 to 1.95	30	1000	2.0	2	9.4	2	9.4	
		2.3 to 2.7	30	500	2.0	2	6.6	2	6.6	
		2.7	50	500	2.5	1	5.6	1	5.6	
		3.0 to 3.6	50	500	2.5	1	5.3	1	5.3	
4.5 to 5.5	50	500	2.5	1	5.0	1	5.0			

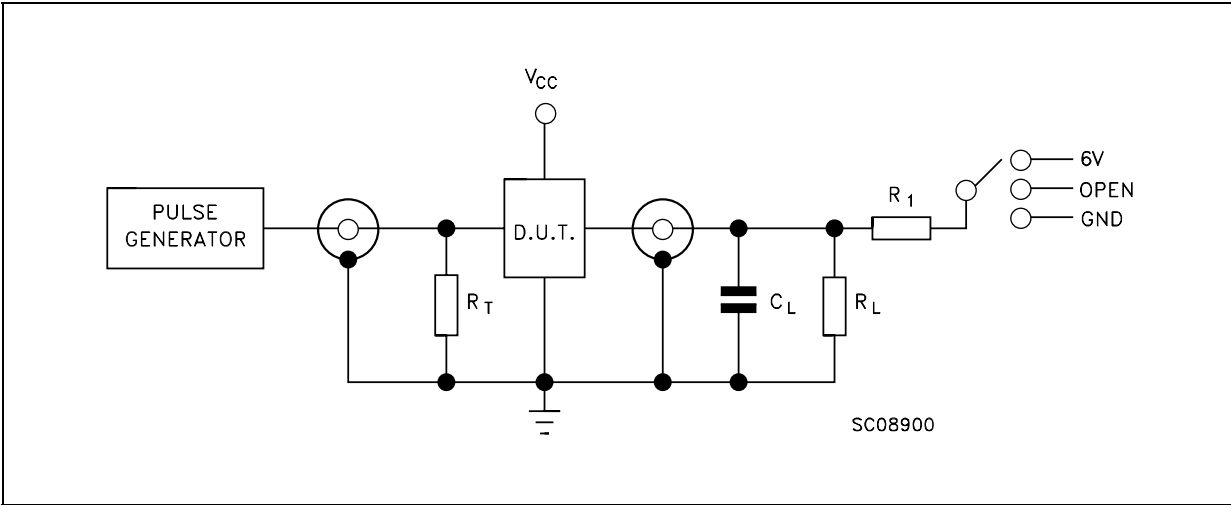
CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Condition		Value			Unit
		V _{CC} (V)		T _A = 25 °C			
				Min.	Typ.	Max.	
C _{IN}	Input Capacitance		V _{IN} = 0 or V _{CC}		4		pF
C _{OUT}	Output Capacitance		V _{IN} = 0 or V _{CC}		5	10	pF
C _{PD}	Power Dissipation Capacitance (note 1)	1.8	f _{IN} = 10MHz		18		pF
		2.5			18		
		3.3			21		

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}$

74LX1G126

TEST CIRCUIT

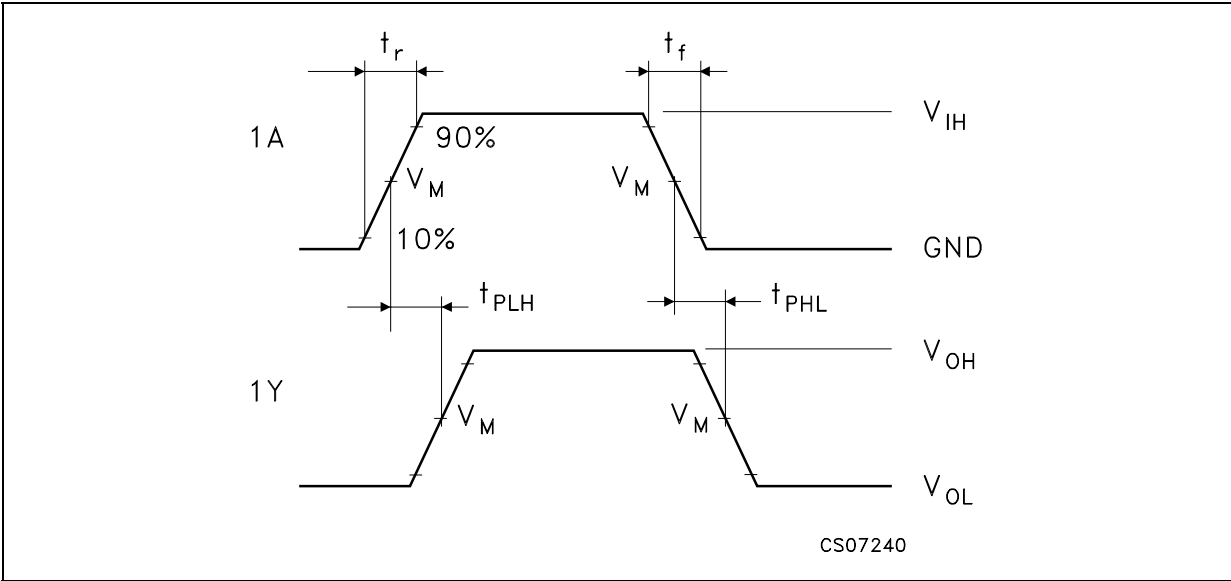


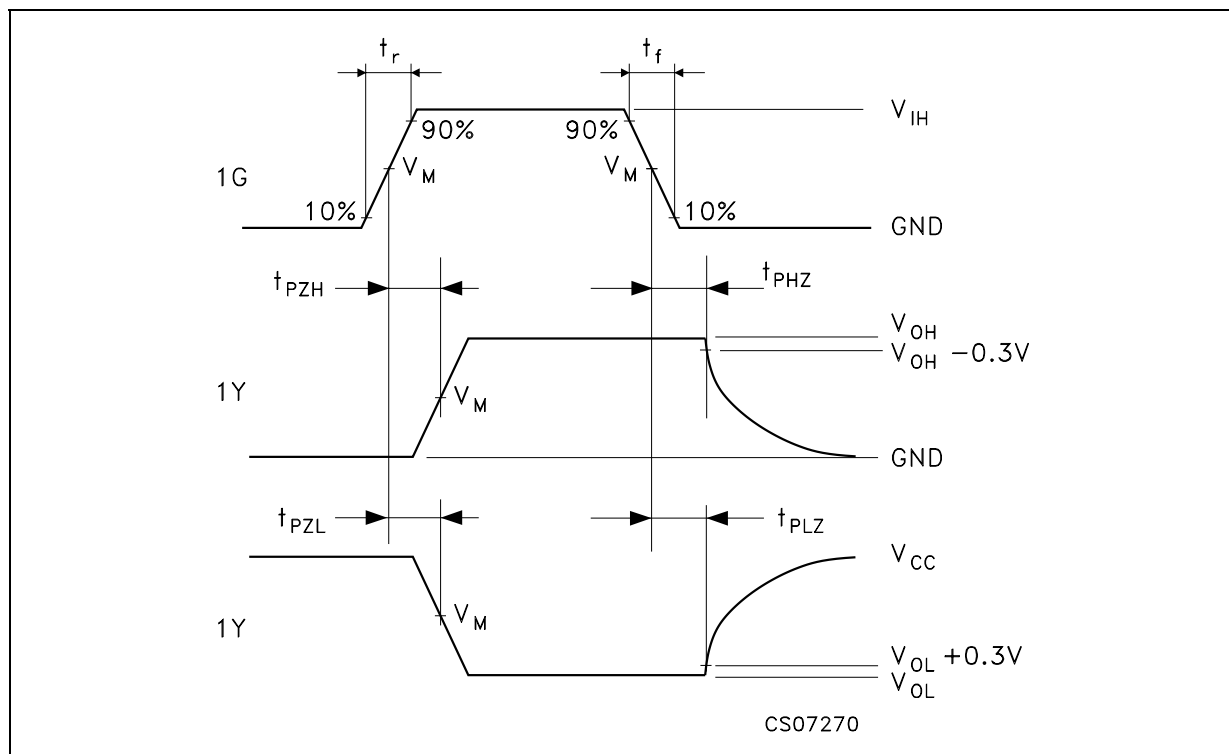
$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

TEST CIRCUIT AND WAVEFORM SYMBOL VALUE

Symbol	V_{CC}		
	1.65 to 1.95V	2.3 to 2.7V	2.7 to 5.5V
C_L	15pF/30pF	15pF/30pF	15pF/50pF
$R_L=R_1$	1MΩ/1000Ω	1MΩ/500Ω	1MΩ/500Ω
V_{IH}	V_{CC}	V_{CC}	V_{CC}
V_M	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$
$t_r = t_f$	<2.0ns	<2.0ns	<2.5ns

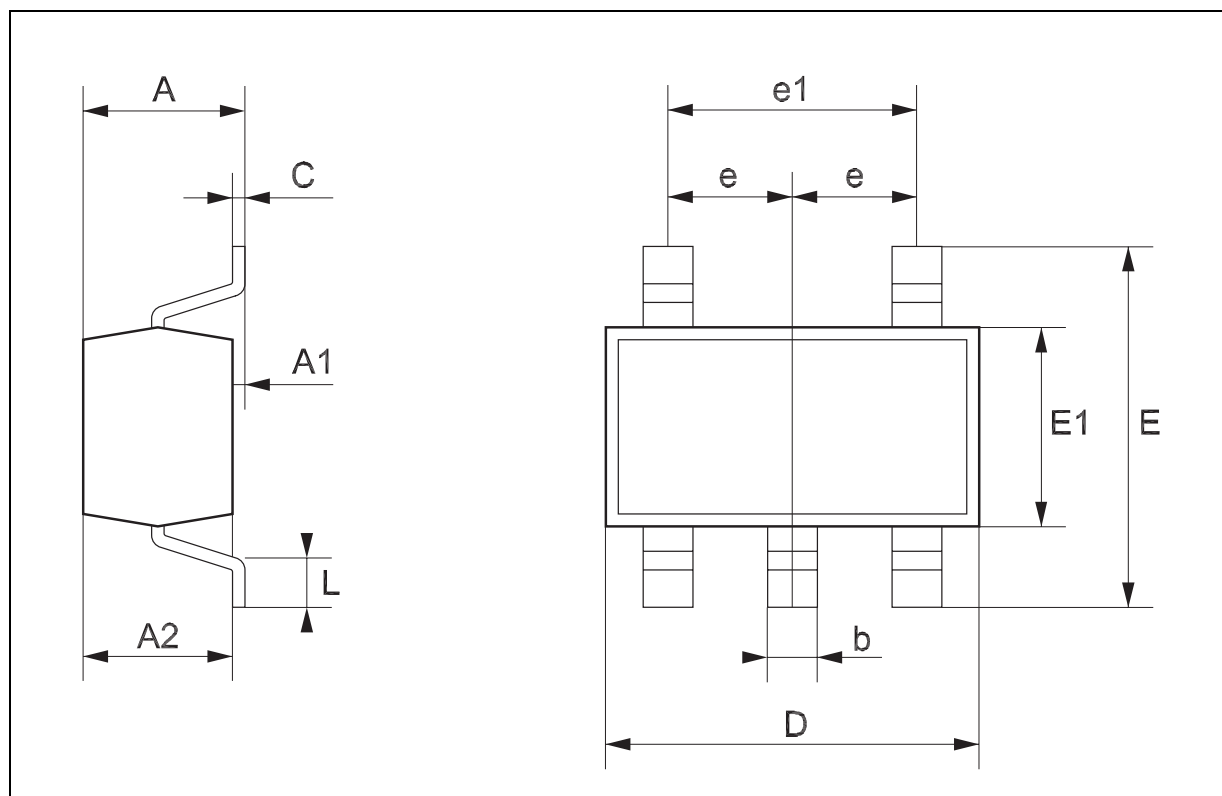
WAVEFORM 1 : PROPAGATION DELAYS (f=1MHz; 50% duty cycle)



WAVEFORM 2: OUTPUT ENABLE AND DISABLE TIME ($f=1\text{MHz}$; 50% duty cycle)

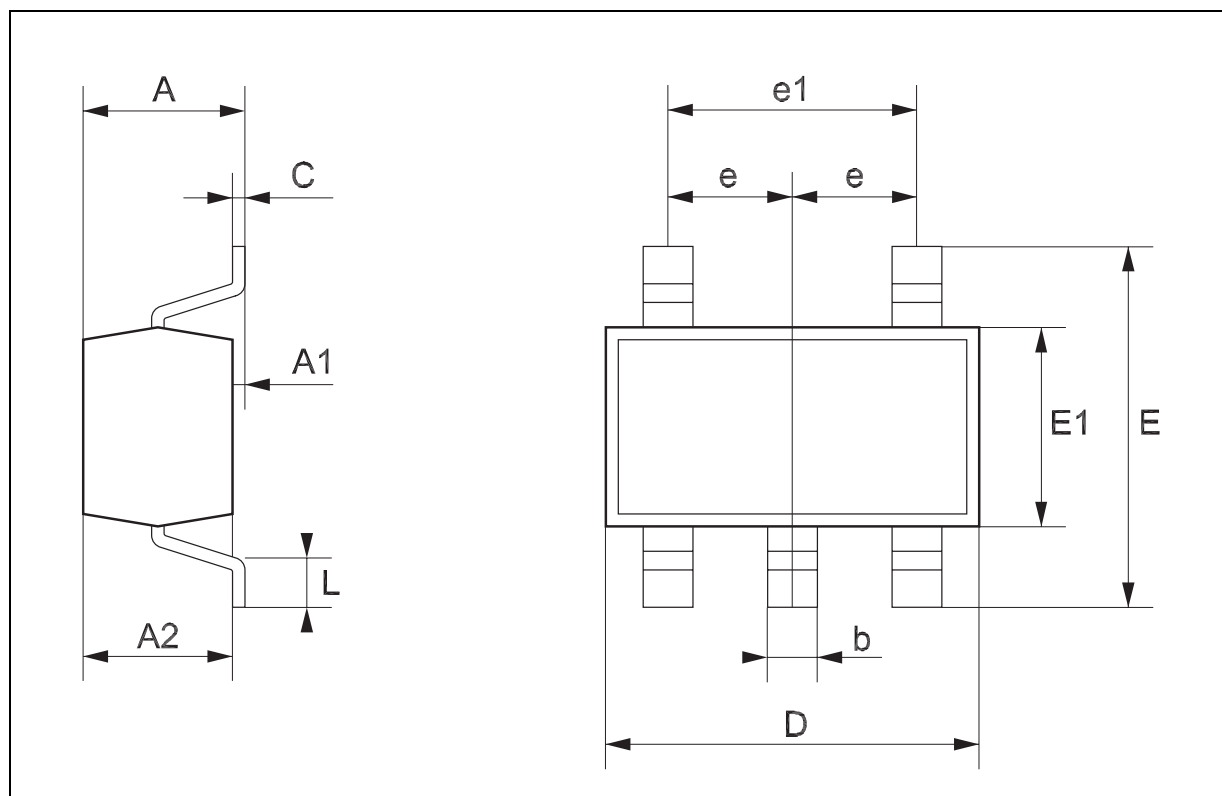
SOT23-5L MECHANICAL DATA

DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.0		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e	0	.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6



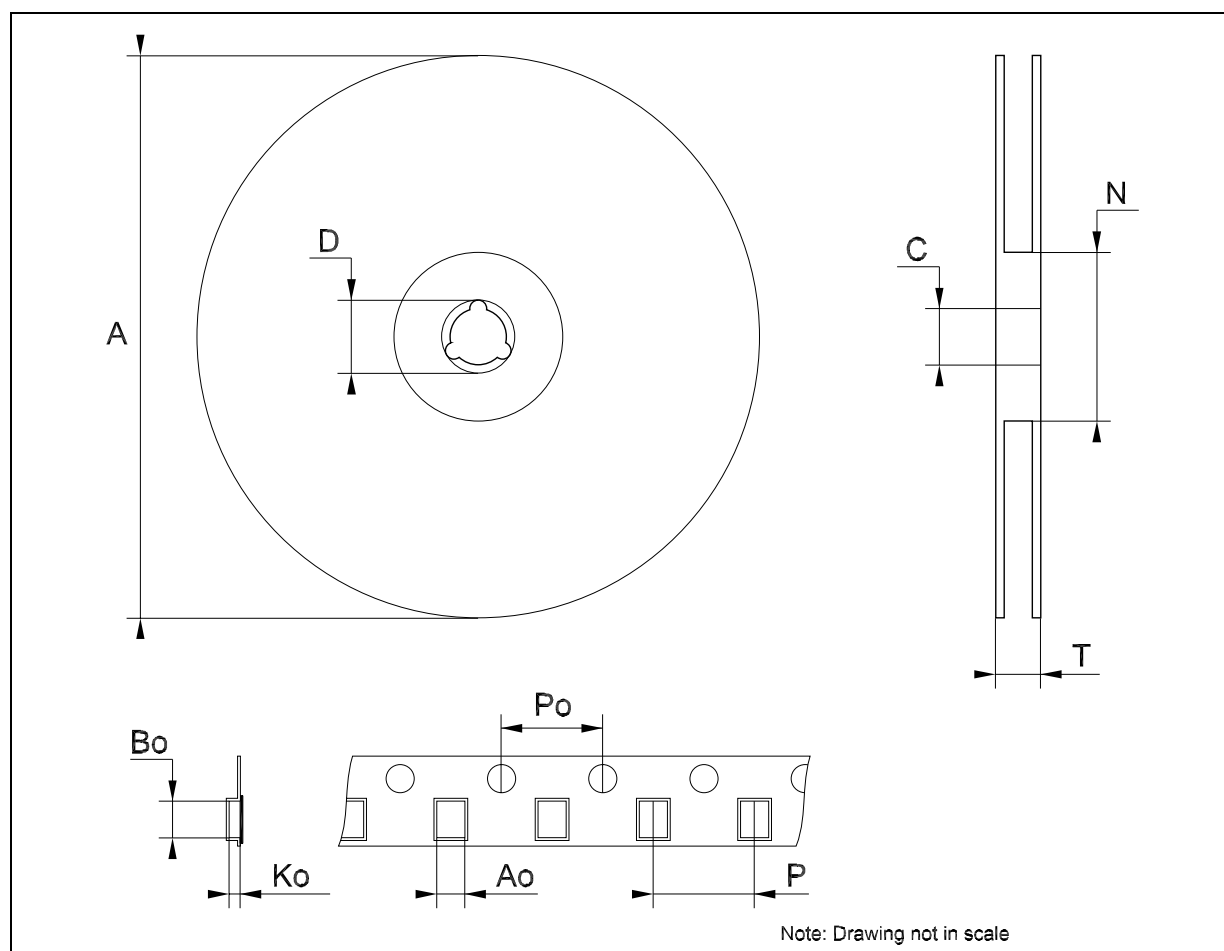
SOT323-5L MECHANICAL DATA

DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	0.80		1.10	31.5		43.3
A1	0.00		0.10	0.0		3.9
A2	0.80		1.00	31.5		39.4
b	0.15		0.30	5.9		11.8
C	0.10		0.18	3.9		7.1
D	1.80		2.20	70.9		86.6
E	1.80		2.40	70.9		94.5
E1	1.15		1.35	45.3		53.1
e	0	.65			25.6	
e1		1.3			51.2	
L	0.10		0.30	3.9		11.8



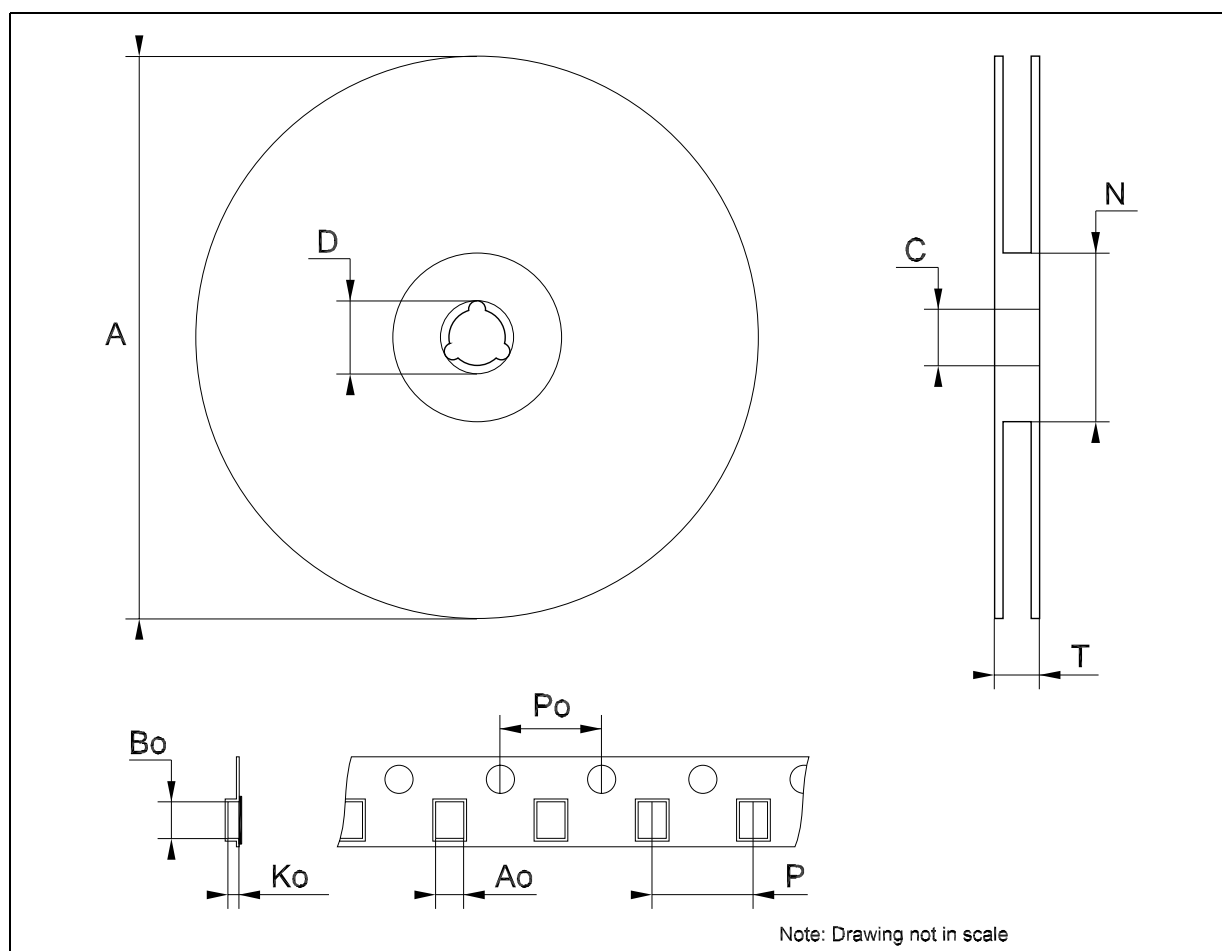
Tape & Reel SOT23-xL MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			180			7.086
C	12.8	13.0	13.2	0.504	0.512	0.519
D	20.2			0.795		
N	60			2.362		
T			14.4			0.567
Ao	3.13	3.23	3.33	0.123	0.127	0.131
Bo	3.07	3.17	3.27	0.120	0.124	0.128
Ko	1.27	1.37	1.47	0.050	0.054	0.058
Po	3.9	4.0	4.1	0.153	0.157	0.161
P	3.9	4.0	4.1	0.153	0.157	0.161



Tape & Reel SOT323-xL MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	175	180	185	6.889	7.086	7.283
C	12.8	13	13.2	0.504	0.512	0.519
D	20.2			0.795		
N	59.5	60	60.5		2.362	
T			14.4			0.567
Ao		2.25			0.088	
Bo		2.7			0.106	
Ko		1.2			0.047	
Po	3.98	4	4.2	0.156	0.157	0.165
P	3.98	4	4.2	0.156	0.157	0.165



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